



FIG. 1

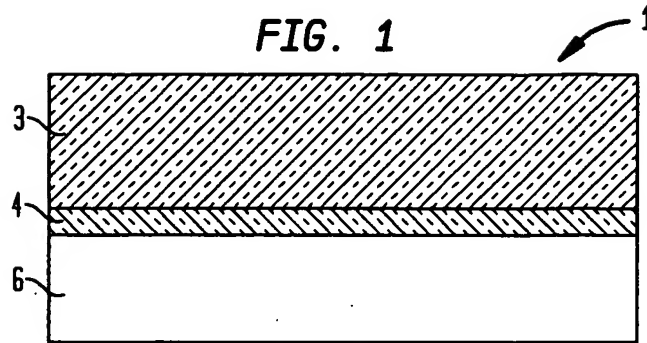


FIG. 2

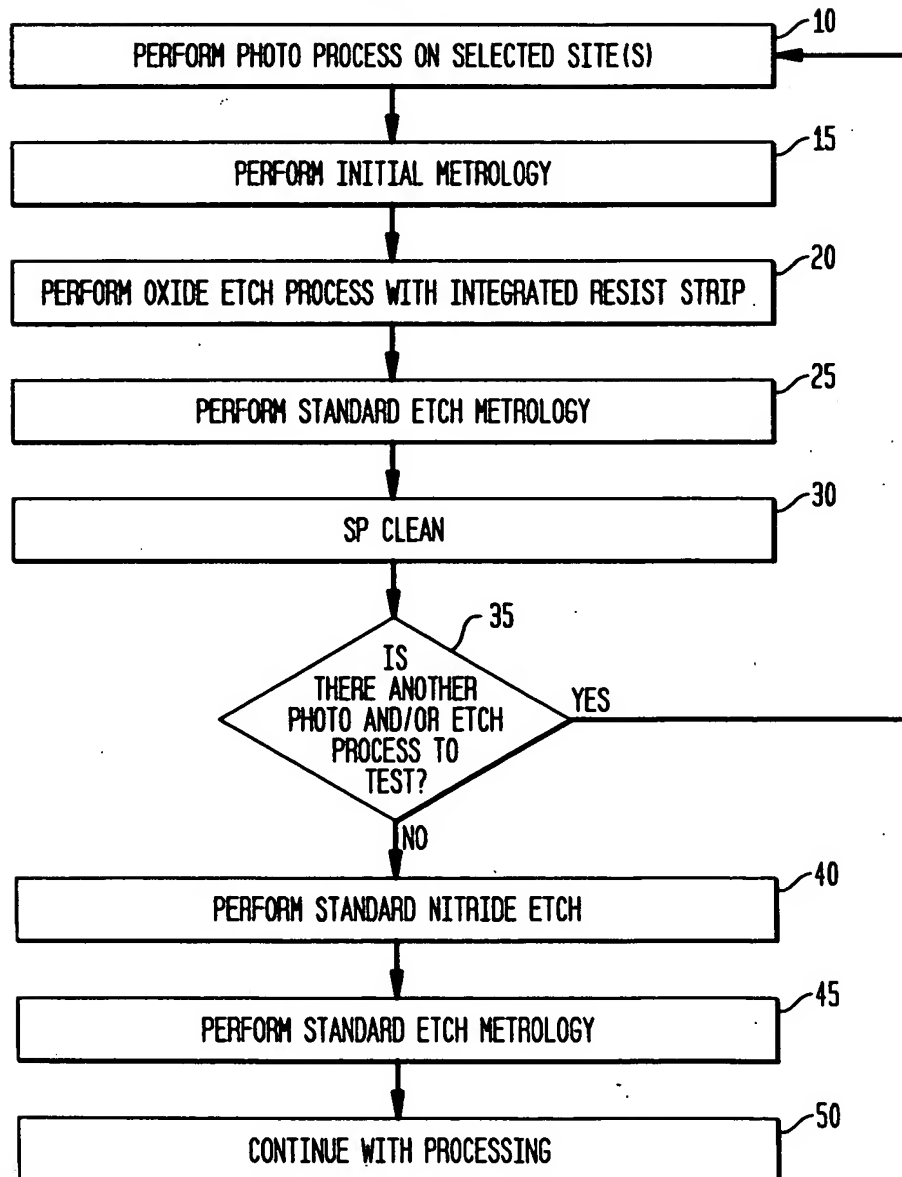


Figure 1 is a circular cross-section of a substrate. The substrate is divided into a grid of square elements. The grid is composed of alternating white and hatched squares. The hatched squares are arranged in a checkerboard pattern. The grid is labeled with 1, 3, and 5.

The diagram shows a circular arrangement of a grid. The grid is 10 columns wide and 10 rows high. The letters are arranged as follows:

		A	A	A	A	A	A	A		
	A	A	A	A	B	A	A	A	A	
	A	A	A	B	B	B	A	A	A	
A	A	B	B	B	B	B	B	A	A	A
A	A	A	B	B	B	B	B	A	A	A
A	A	A	A	B	B	B	B	A	A	A
	A	A	A	B	B	B	B	A	A	
		A	A	A	A	A	A	A		
			A	A	A	A	A			

FIG. 5

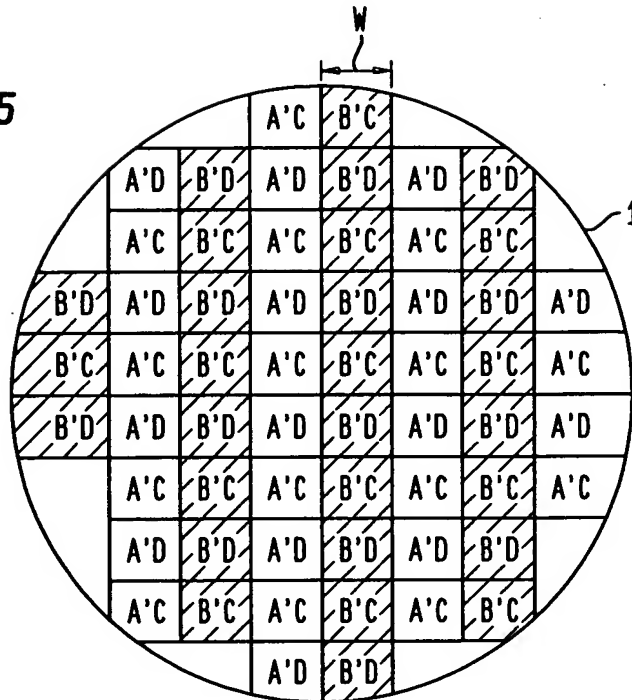


FIG. 6

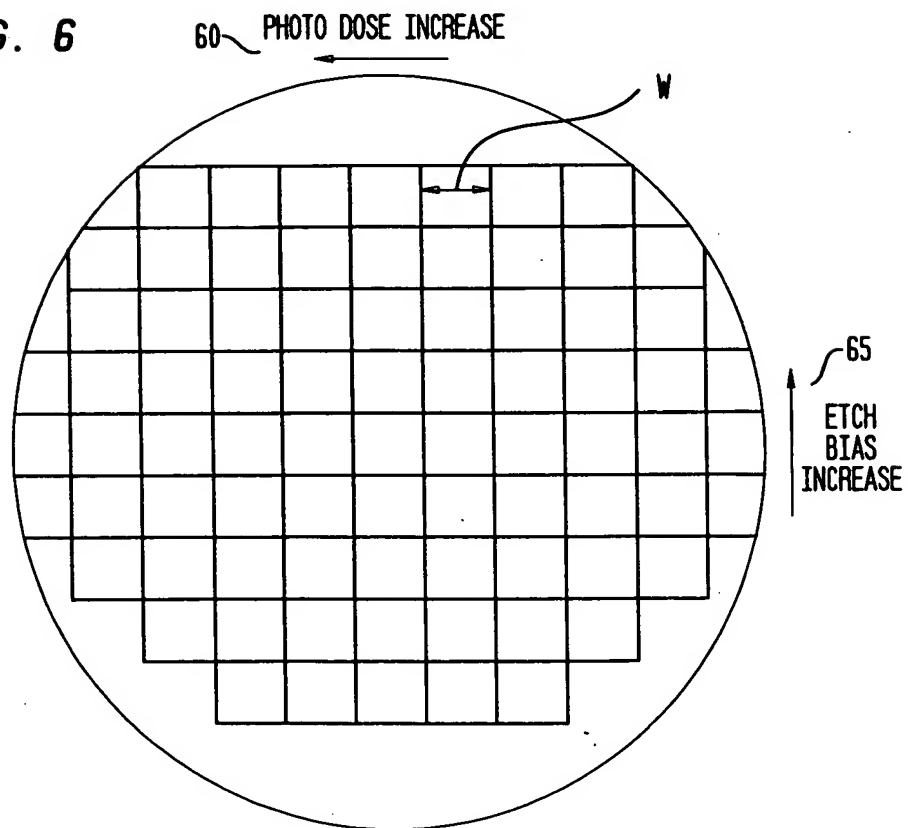


FIG. 7

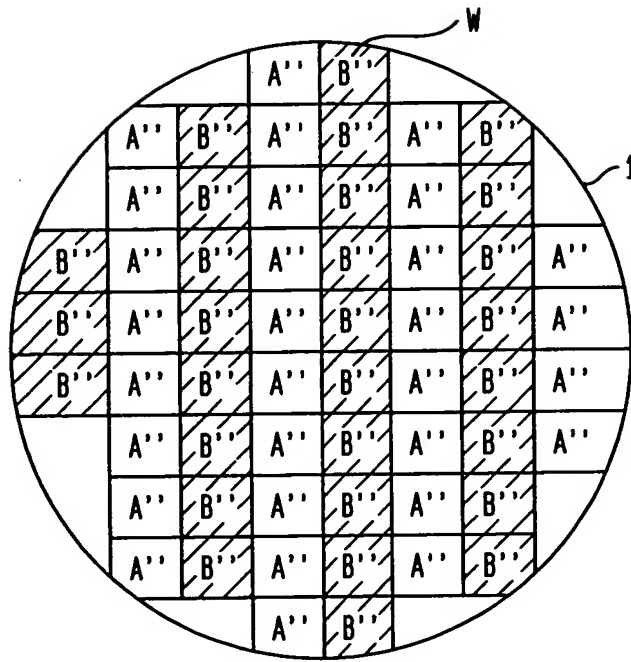


FIG. 8

PROCESS FLOW FOR MULTI-PART NUMBER WAFERS

